APPLICATION DATA SHEET

Electronic Version v14

Stylesheet Version v14.0

Title of Invention

RF TRANSCEIVER MODULE FORMED IN MULTI-LAYERED CERAMIC

Application Type : regular, utility
Attorney Docket Number : CMDP0005USA

Correspondence address:

Customer Number: 027765

Inventors Information:

Inventor 1:

Applicant Authority Type: Inventor
Citizenship: TW
Given Name: Ko-Mai
Family Name: Li

Residence:

City of Residence: Taipei City

Country of Residence: TW

Address-1 of Mailing Address: 3F, No.278, Sec. 3, Chung-Hsiao E. Rd.

Address-2 of Mailing Address:

City of Mailing Address: Taipei City

State of Mailing Address:

Postal Code of Mailing Address:

Country of Mailing Address: TW

Phone: Fax:

E-mail:

Inventor 2:

Applicant Authority Type: Inventor
Citizenship: TW
Given Name: Yo-Shen

Family Name: Yo-Shen Lin

Residence:

City of Residence: Taipei City

Country of Residence: TW

Address-1 of Mailing Address: 1F, No.40, Lane 45, Sec. 2, Chih-Nan Rd.

Address-2 of Mailing Address:

City of Mailing Address: Taipei City

State of Mailing Address:

Postal Code of Mailing Address:

Country of Mailing Address: TW

Phone:

Fax: E-mail:

Inventor 3:

Applicant Authority Type: Inventor **Citizenship:** TW

Given Name: Chien-Chang

Family Name: Liu

Residence:

City of Residence: Taipei City

Country of Residence: TW

Address-1 of Mailing Address: 2F, No. 85, Lin-Kou St.

Address-2 of Mailing Address:

City of Mailing Address: Taipei City

State of Mailing Address:

Postal Code of Mailing Address:

Country of Mailing Address: TW

Phone: Fax:

E-mail:

Attorney Information:

practitioner(s) at Customer Number:

027765



as our attorney(s) or agent(s) to prosecute the application identified above, and to transact all business in the United States Patent and Trademark Office connected therewith.